

HAT2027R

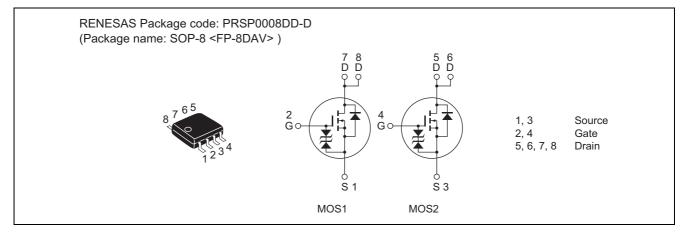
Silicon N Channel Power MOS FET High Speed Power Switching

> REJ03G1162-0800 (Previous: ADE-208-458F) Rev.8.00 Sep 07, 2005

Features

- Low on-resistance
- Capable of 2.5 V gate drive
- Low drive current
- High density mounting

Outline





Absolute Maximum Ratings

			$(Ta = 25^{\circ}C)$
Item	Symbol	Value	Unit
Drain to source voltage	V _{DSS}	20	V
Gate to source voltage	V _{GSS}	±12	V
Drain current	ID	7	А
Drain peak current	I _{D (pulse)} Note 1	56	А
Body-drain diode reverse drain current	I _{DR}	7	А
Channel dissipation	Pch Note 2	2	W
Channel dissipation	Pch Note 3	3	W
Channel temperature	Tch	150	٥C
Storage temperature	Tstg	-55 to +150	٥C

Notes: 1. PW \leq 10 $\mu s,\,duty\,cycle \leq$ 1%

2. 1 Drive operation: When using the glass epoxy board (FR4 40 \times 40 \times 1.6 mm), PW \leq 10 s

3. 2 Drive operation: When using the glass epoxy board (FR4 40 \times 40 \times 1.6 mm), PW \leq 10 s

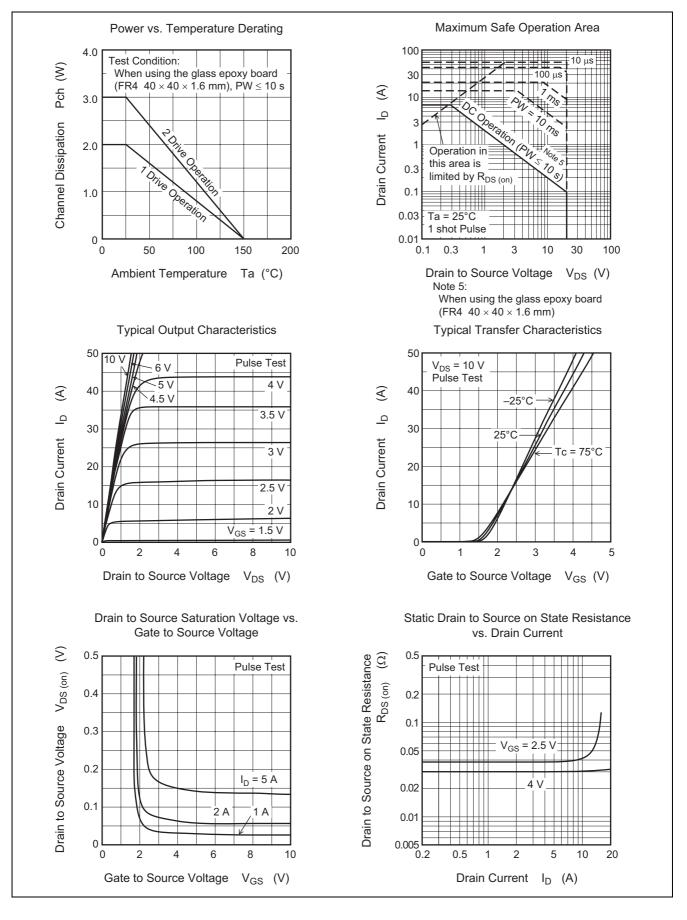
Electrical Characteristics

						$(Ta = 25^{\circ}C)$
Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Drain to source breakdown voltage	V (BR) DSS	20	—		V	$I_D = 10 \text{ mA}, V_{GS} = 0$
Gate to source breakdown voltage	V (BR) GSS	±12	—	_	V	$I_G = \pm 100 \ \mu A, \ V_{DS} = 0$
Gate to source leak current	I _{GSS}	—	—	±10	μA	$V_{GS} = \pm 10 \text{ V}, \text{ V}_{DS} = 0$
Zero gate voltage drain current	I _{DSS}	—	—	10	μA	$V_{DS} = 20 V, V_{GS} = 0$
Gate to source cutoff voltage	V _{GS (off)}	0.5	—	1.5	V	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 1 \text{ mA}$
Static drain to source on state resistance	R _{DS (on)}	—	0.03	0.038	Ω	$I_D = 4 \text{ A}, V_{GS} = 4 \text{ V}^{Note 4}$
	R _{DS (on)}	—	0.038	0.053	Ω	$I_D = 4 \text{ A}, V_{GS} = 2.5 \text{ V}^{Note 4}$
Forward transfer admittance	y _{fs}	9	14	_	S	$I_D = 4 \text{ A}, V_{DS} = 10 \text{ V}^{\text{Note 4}}$
Input capacitance	Ciss	—	720	_	pF	V _{DS} = 10 V
Output capacitance	Coss	—	450	_	pF	$V_{GS} = 0$
Reverse transfer capacitance	Crss	—	185	_	pF	f = 1 MHz
Turn-on delay time	t _{d (on)}	—	28	_	ns	$V_{GS} = 4 V, I_D = 4 A,$
Rise time	tr	—	145	_	ns	$V_{DD} \cong 10 \text{ V}$
Turn-off delay time	t _{d (off)}	—	100	_	ns	
Fall time	t _f		125		ns	
Body-drain diode forward voltage	V _{DF}		0.9	1.4	V	$I_F = 7 \text{ A}, V_{GS} = 0^{\text{Note 4}}$
Body-drain diode reverse recovery time	t _{rr}		60	_	ns	$I_F = 7 \text{ A}, V_{GS} = 0$
						di _F /dt = 20 A/µs

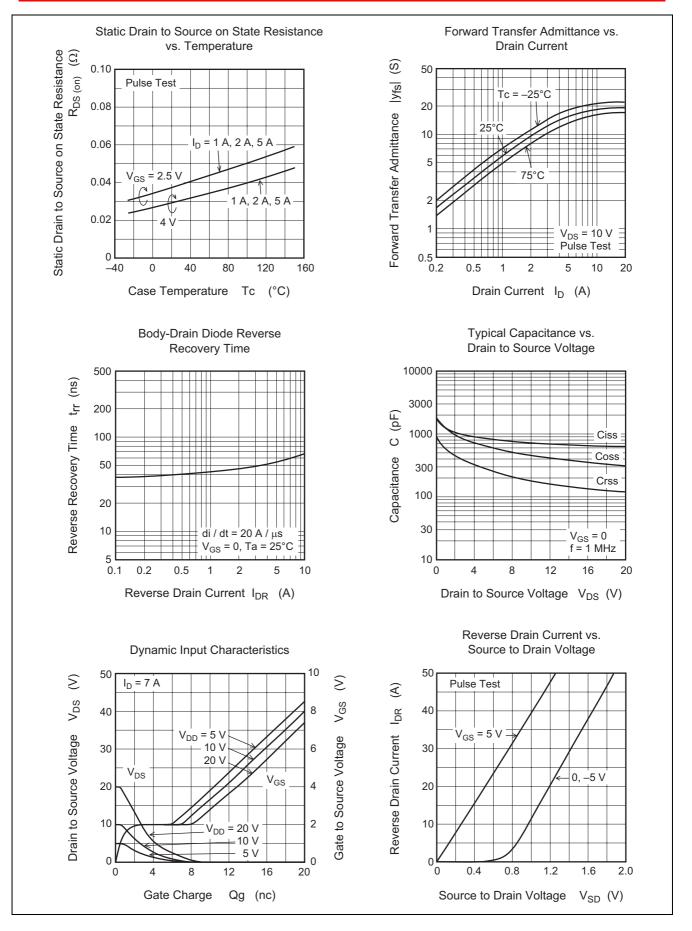
Note: 4. Pulse test



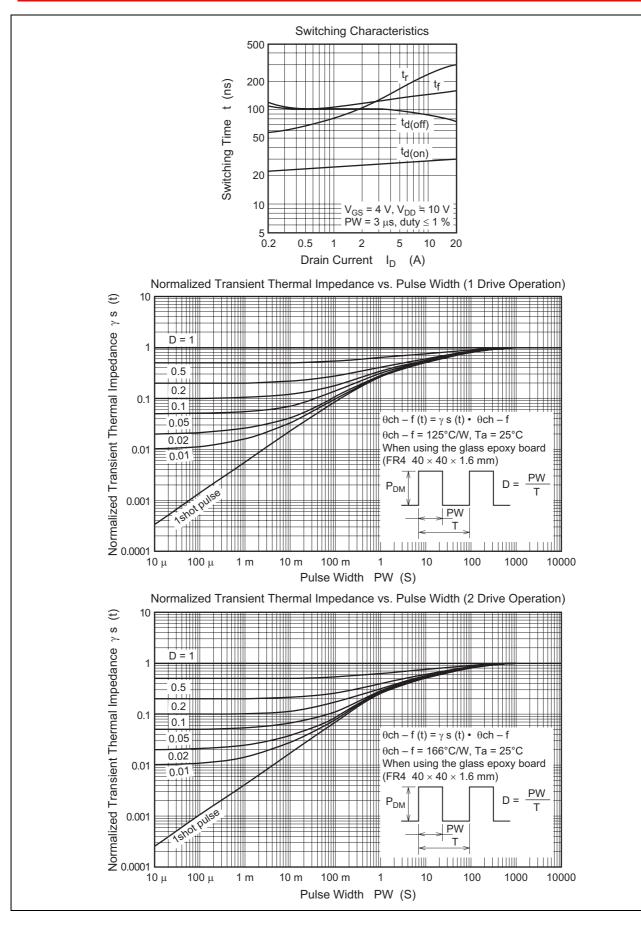
Main Characteristics



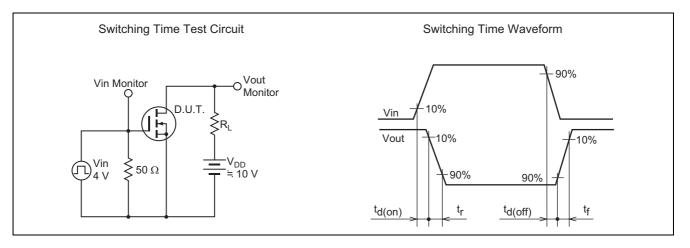






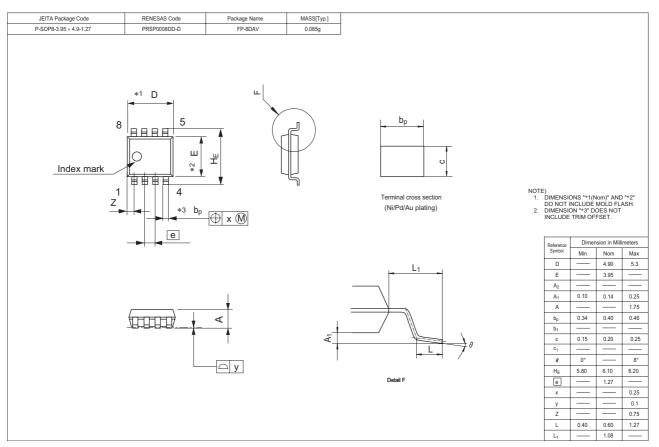








Package Dimensions



Ordering Information

Part Name	Quantity	Shipping Container
HAT2027R-EL-E	2500 pcs	Taping

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.



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